



Model 1190300-XXX 24.576 MHz, Stratum 3E OCXO

Features

- Industry standard 25.4 x 22 mm SMT package
- Stratum 3E per GR-1244-Core and CR-253-Core
- 3.3V or 5.0V operation
- Low Phase Noise
- Tape and Reel packaging

Applications

- Telecom Switching
- Wireless Communication
- Timing over Packet



ppb pk-pk

25.4 x 22 x 12.7 mm

Description

Holdover (24 hours)

The CTS model 1190300 is a low cost, small size, high performance OCXO. The high quality CTS Quartz Crystal used in this OCXO offers high stability and low jitter/phase noise, making it the ideal choice for any telecommunications system

Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit	
Operating Conditions						
Operating Temperature Range		-40	-	+85	°C	
Committee and	3.3V	3.135	3.3	3.465		
Supply Voltage	5.0V	4.75	5.0	5.25	Vdc	
D 0 1	Warm up	-	-	3.2		
Power Consumption	Steady state @ 25°C	-	-	1.2	W	
Load	Output to Ground	5	10	15	pf	
Frequency Stability						
Frequency	Fnom		24.576		MHz	
Calibration	Δ F/F _{NOM} ; at time of shipment	-	±75	+200	ppb	
Temperature Stability	See options table	-	7	10	ppb pk-pk	
Voltage Stability	±5%	-	±1	±3	ppb	
	Per day, at time of shipment	-	±0.5	±1	ppb/day	
Aging	First year	-	-	±100	ppb	
	10 years	-	-	±700	ppb	
Holdover (24 hours)	Inclusive of operating temp and			11	nnh nk-nk	

24 hours aging drift - See Table 1



Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit	
Operating Conditions C	Continued					
Total Free-Run Accuracy	Under all conditions for 10 years	-	-	±2.5	ppm	
Drift	24 hours at constant temperature – See Table 1	-	-	±1	ppb	
	1.0 sec	-	< 0.01	0.02		
Chart Tarra Stability	10 sec	-	0.01	0.03		
Short Term Stability	100 sec	-	0.02	0.05	ppb	
ADEV (in still air)	1000 sec	-	0.05	0.1		
	10,000 sec	-	0.07	0.2		
Wander Generation	MTIE and TDEV per Stratum 3E requirements per GR-1244-CORE and GR-253-CORE					
Warm-Up Time	$T_A = 25$ °C; to within 50 ppb of frequency @ 30 minutes	-	-	5	minutes	
Output Parameters – H	CMOS					
A 19 1 .	Vol	-	-	10% Vcc		
Amplitude	Voh	90% Vcc	-	-	V	
Rise / Fall Times	10% to 90% @ 10pf load	-	-	8	nsec	
Duty Cycle	@ 50% of output signal	45	-	55	%	
Spurious		-	-	-70	dBc	
	Offset = 10Hz	-	-115	-110		
Phase Noise	100Hz	-	-140	-135	dBc/Hz	
i ilase NOISE	1KHz	-	-150	-145	ивс/пг	
	10KHz	-	-155	-150		

Table 1 – Aging Recovery		
Time Off	Minimum power on time to	
Time on	recover daily aging rate	
≤ 1 day	24 hours	
< 1 week	3 days	
< 1 month	6 days	

Options and Part Number

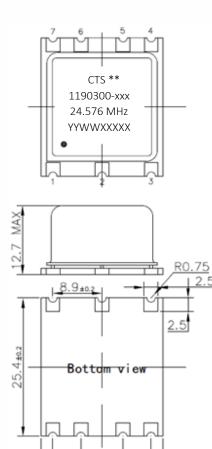
Dash No.	Supply voltage	Operating Temp. Range	Part Number
-001	+5.0 Vdc	-20°C to +70°C	1190300-001
-002	+5.0 Vdc	-40°C to +85°C	1190300-002
-003	+3.3 Vdc	-20°C to +70°C	1190300-003
-004	+3.3 Vdc	-40°C to +85°C	1190300-004



Mechanical and Environmental

Soldering	Maximum reflow temperature, 245°C for 10 seconds, 240°C for 20 seconds, per IPC/JEDEC J-STD-020C
MSL	Level 1
RoHS	Lead-Free. Fully compliant to RoHS Directive 2011/65/EU
Shock	500 G's, 1msec, 5 shocks in each of 6 directions
Sinusoidal Vibration	10 Hz to 55 Hz with a double amplitude of 1.5 mm, 10 g's peak from 55 Hz to 2000Hz, for
	30 minutes in each of three perpendicular directions
Random Vibration	5.35 G's RMS. 20 to 500 Hz, per MIL-STD-202F,
	Method 214, 15 minutes each axis.
Seal	Hermetic
Marking Permanency	Per MIL-STD-202F, Method 215J
Attachment Method	SMT
Storage Temp Range	-40 to +85°C

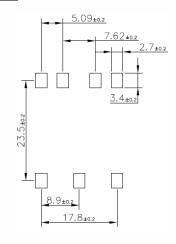
Mechanical Specifications



Marking			
**	Mfg Site Code		
-XXX	P/N option		
YYWWXXXXX	DC/Serial Number		

Pin Assignments		
Pin	Function	
1	NC	
2	NC	
3	V_{CC}	
4	Output	
5	NC	
6	NC	
7	Ground	

Recommended Solder Pad Geometry

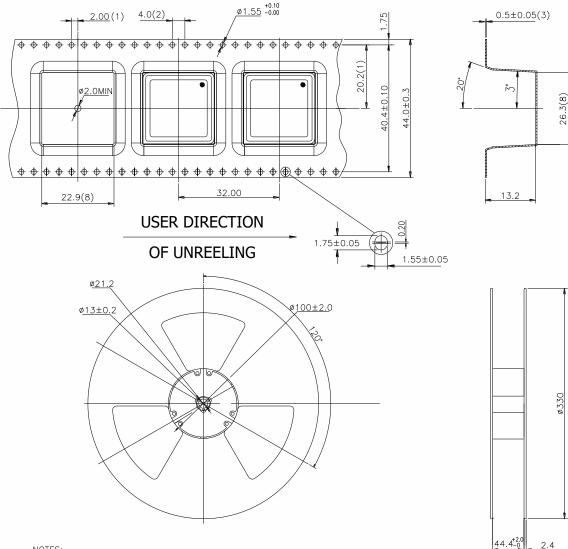


Pad termination: Gold Flash <10 micro inch, over Ni plated Cu

7.8±0.3

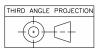


Packing: Tape and Reel



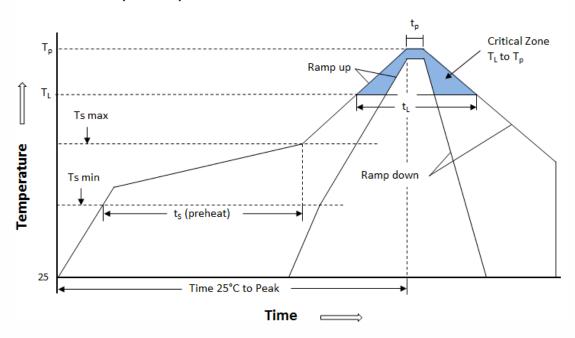
NOTES:

- MEASURED FROM THE CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF THE POCKET HOLE AND FROM THE CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF THE POCKET
- 2. CUMULATIVE TOLERANCE OF 10 SPROCKET HOLES IS ±0.20
- THIS THICKNESS IS APPLICABLE AS MEASURED AT THE EDGE OF THE TAPE
- 4. MATERIAL:BLACK POLYSTYRENE
- 5. DIM IN MM
- ALLOWABLE CAMBER TO BE 1mm PER 100mm IN LENGTH, NON-CUMULATIVE OVER 250mm
- 7. UNLESS OTHERWISE SPECIFIED, TOLERANCE ±0.10
- 8. MEASUREMENT POINT TO BE 0.3 ABOVE THE INDICATED
- SURFACE RESISTIVITY:FROM105TO 101 DHMS/SQ
- 10. MAXIMUM QUANTITY 50 UNITS IN ONE TAPE&REEL





Reflow profile per IPC/JEDEC J-STD-020C



Note: The temperatures shown below represent the device body temperature

Ts max to T _L (Ramp-up Rate)	3°C/second max
Preheat	
Temperature Min(Ts Min)	150°C
Temperature Typical(Ts Typ)	175°C
Temperature Max.(Ts Max)	200°C
Time(ts)	60-180 seconds
Ram-up Rate(T _L to Tp)	3°C/second max
Time Maintained Above:	
Temperature(T _L)	217°C
Time(T _L)	60-150seconds
Peak Temperature (Tp)	245°C max for 10 seconds
Time within 5°C of actual peak(tp)	20 seconds
Ramp-down Rate	6°C/second max
Tune 25°C to Peak Temperature(t)	8 minutes max

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